

PROTECTION PRODUCTS

Absolute Maximum Rating

Rating	Symbol	Value	Units
Steady-State Power	P_{SS}	100	mW
ESD Air Discharge per IEC 61000-4-2 ESD Contact Discharge per IEC 61000-4-2	V_{ESD}	25 20	kV
Lead Soldering Temperature	TL	260 (10 sec.)	°C
Operating Temperature	T_J	-40 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

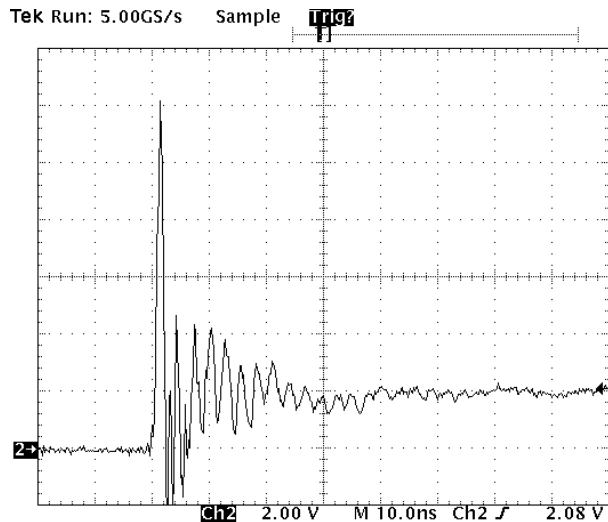
Electrical Characteristics (T = 25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
TVS Reverse Stand-Off Voltage	V_{RWM}				5.25	V
TVS Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$	6			V
TVS Reverse Leakage Current	I_R	$V_{RWM} = 5.25V, T=25^{\circ}C$ Pin 1 to 6			5	μA
Series Resistance	R_S	Each Line	20	22	24	Ω
Pulldown Resistance	R_{PD}	Each Line	13.5	15	16.5	k Ω
Clamping Voltage	V_C	$I_{PP} = 3A, t_p = 8/20\mu s$ Pin 2 or Pin 3 to Pin 6			11	V
TVS Diode Capacitance	C	Each Line $V_R = 0V, f = 1MHz$	27	30	33	pF
Total Capacitance	C_{TOT}	Between Input or Output to Ground $V_R = 0V, f = 1MHz$		50		pF

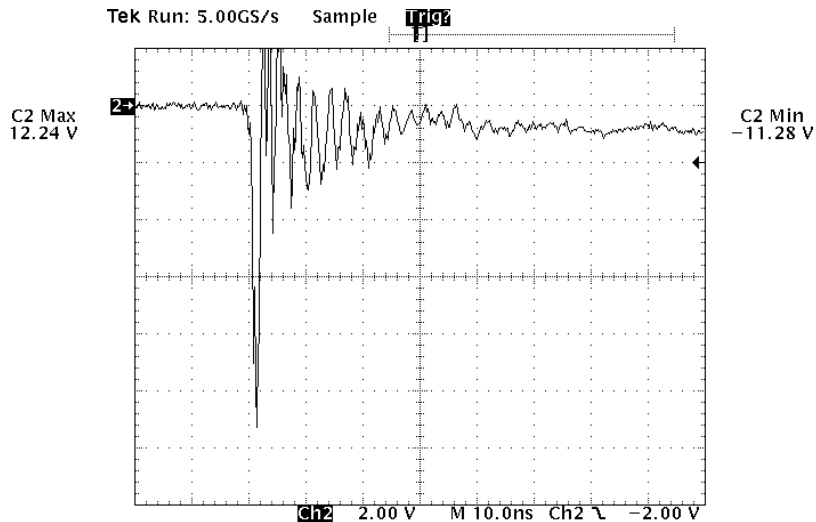
PROTECTION PRODUCTS

Typical Characteristics

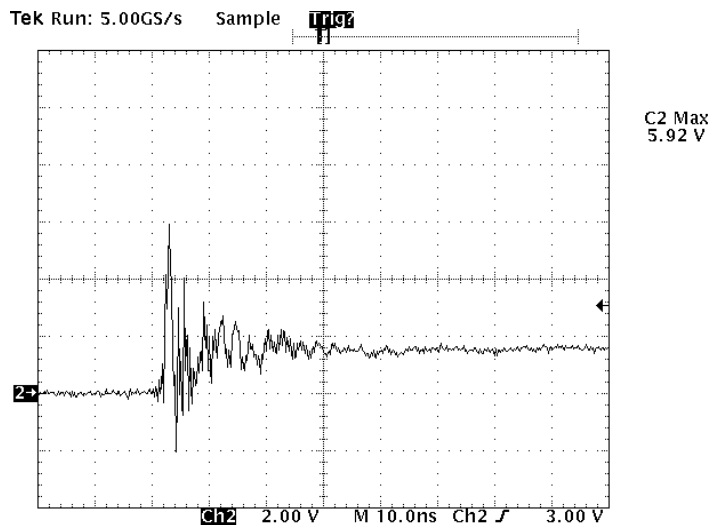
**ESD Clamping (Pin 1 to GND)
(8kV Contact per IEC 61000-4-2)**



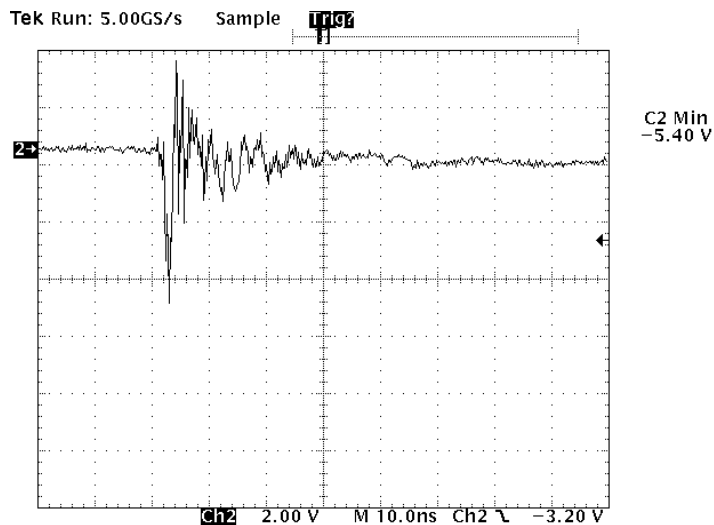
**ESD Clamping (Pin 1 to GND)
(-8kV Contact per IEC 61000-4-2)**



**ESD Clamping (Pin 4 or 5 to GND)
(8kV Contact per IEC 61000-4-2)**



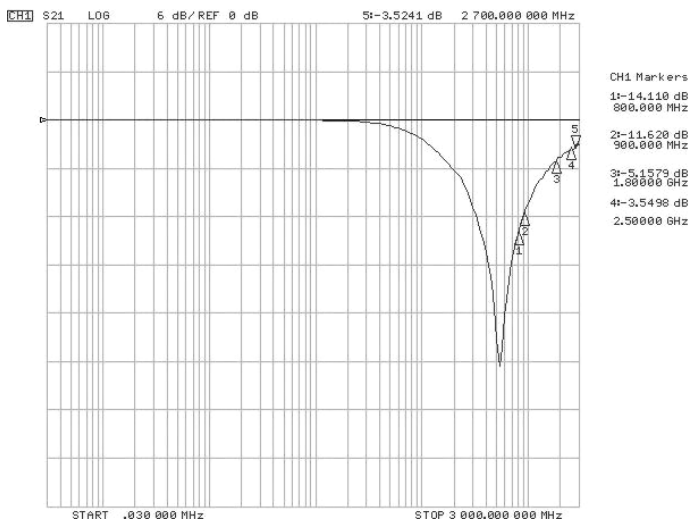
**ESD Clamping (Pin 4 or 5 to GND)
(-8kV Contact per IEC 61000-4-2)**



Note: ESD data is taken with a 20dB attenuator

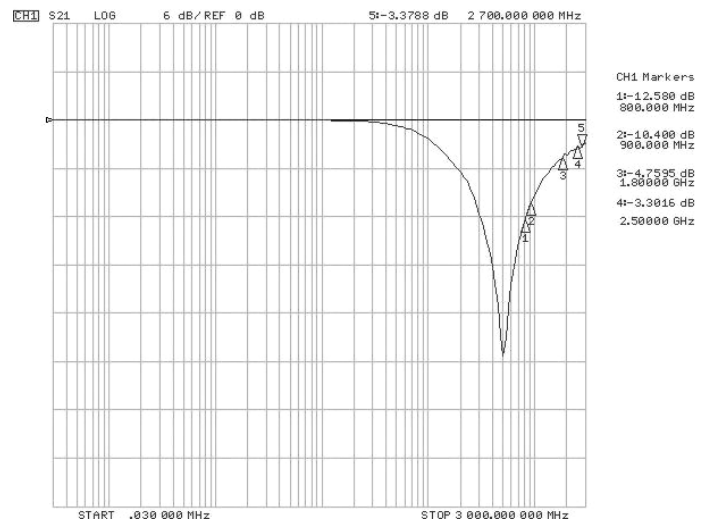
PROTECTION PRODUCTS

**Typical Insertion Loss S21
(Pin 2 to 5 with respect to GND)**



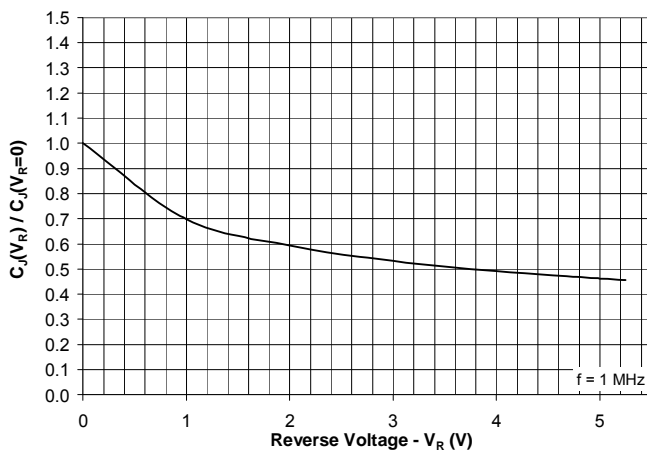
Frequency	S21 (dB)
114.9MHz	-3.00
800MHz	-14.11
900MHz	-11.62
1.8GHz	-5.16
2.5GHz	-3.55
2.7GHz	-3.52

**Typical Insertion Loss S21
(Pin 3 to 4 with respect to GND)**

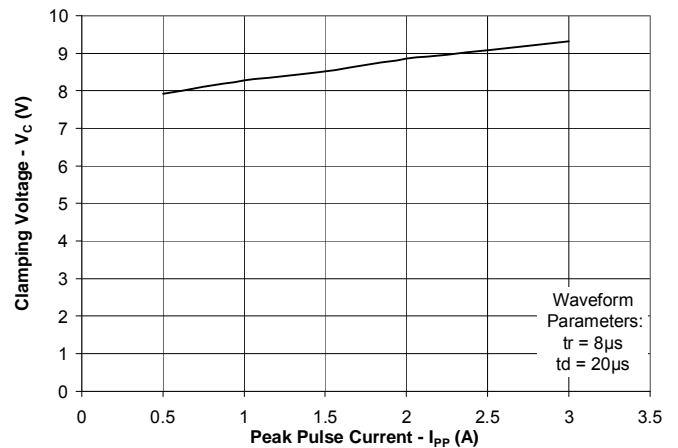


Frequency	S21 (dB)
114.6MHz	-3.00
800MHz	-12.58
900MHz	-10.40
1.8GHz	-4.76
2.5GHz	-3.30
2.7GHz	-3.38

**Normalized Junction Capacitance
vs. Reverse Voltage (Data Pins)**



**Clamping Voltage vs. Peak Pulse Current
(Between any I/O and Ground)**



PROTECTION PRODUCTS

Applications Information

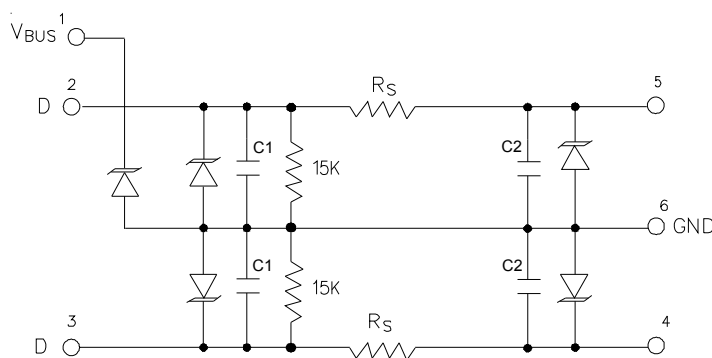
Device Connection

The EClamp2122S is designed to provide termination, EMI filtering and ESD protection for two USB I/O lines. The equivalent circuit diagram is shown in Figure 1.

The device is connected as follows:

- USB data lines are routed through the EClamp2122S for easy implementation and optimum pc board layout. Pin 1 is connected to the voltage supply line. The input of the D+ line is routed into pin 2 and out of pin 5. The input of the D- line is connected at pin 3 and the output at pin 4. Pin 6 is connected to ground. The ground connection should be made directly to the ground plane for best results. The path length is kept as short as possible to reduce the effects of parasitic inductance in the board traces.

Figure 1 - EClamp2122S Circuit Diagram



USB Port Design with EClamp2122S

The Universal Serial Bus (USB) specification requires termination and filtering components for proper operation. In addition, an open USB socket is vulnerable to hazardous ESD discharges in excess of 15kV. These discharges can occur on the data lines or the voltage bus. The EClamp2122S is an easily implemented solution designed to meet the termination & EMI filter requirements of the USB specification revision 1.1. It also provides ESD protection to IEC 61000-4-2.

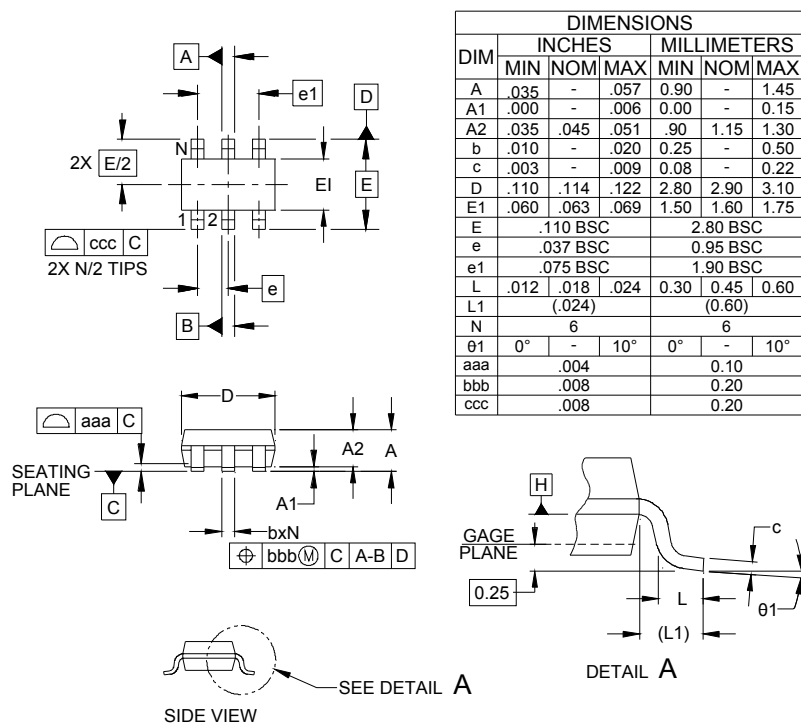
USB line termination is achieved with series resistors on both the D+ and D- lines. These resistors preserve signal integrity by matching the cable impedance to that of the differential driver. 15kΩ pull-down resistors are used to identify a downstream port. Capacitors are used to bypass high frequency energy to ground and for edge rate control of the USB signals. Integrated TVS diodes provide ESD protection of both (D+ & D-) data lines and the voltage bus (V_{BUS}).

General layout guidelines are given below:

- Avoid running D+ & D- signal line traces near high speed clock lines or similar signal lines.
- Avoid running critical signal lines near board edges.
- Place the EClamp2122S near the USB connector to restrict transient coupling.
- Minimize the path length between the USB connector and the EClamp2122S.

PROTECTION PRODUCTS

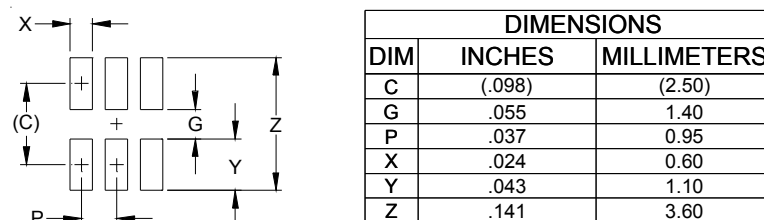
Outline Drawing - SOT-23 6L



NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DATUMS $\boxed{-A-}$ AND $\boxed{-B-}$ TO BE DETERMINED AT DATUM PLANE $\boxed{-H-}$
3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

Land Pattern - SOT-23 6L

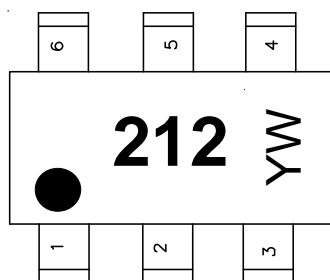


NOTES:

1. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

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Marking



Ordering Information

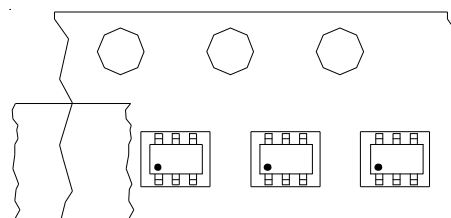
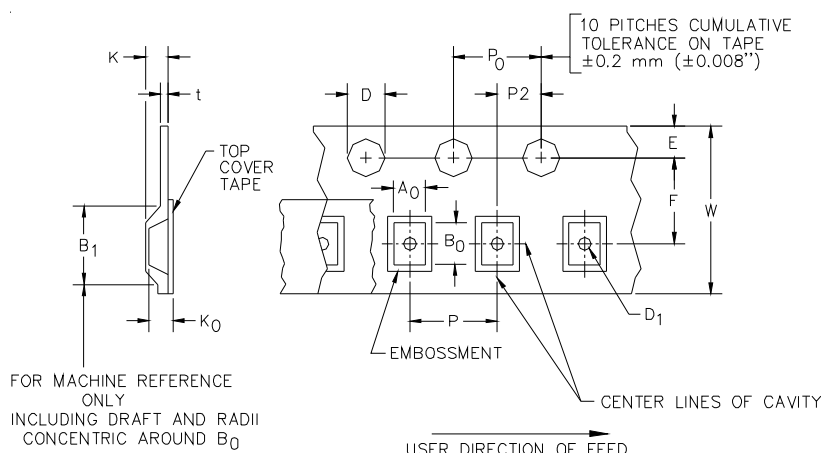
Part Number	Qty per Reel	Reel Size
EClamp2122S.TCT	3,000	7 Inch

Note: Lead finish is lead-free matte tin

EMIClamp and EClamp are trademarks of Semtech Corporation

YW = 2 - Alphanumeric characters for Date Code

Tape and Reel Specification



→
User Direction of feed

Device Orientation in Tape

A0	B0	K0
3.23 +/-0.05 mm	3.17 +/-0.05 mm	1.37 +/-0.05 mm

Tape Width	B, (Max)	D	D1	E	F	K (MAX)	P	P0	P2	T(MAX)	W
8 mm	4.2 mm (.165)	1.5 + 0.1 mm - 0.0 mm	1.0 mm ±0.05	1.750±.10 mm	3.5±0.05 mm	2.4 mm	4.0±0.1 mm	4.0±0.1 mm	2.0±0.05 mm	0.4 mm	8.0 mm + 0.3 mm - 0.1 mm

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